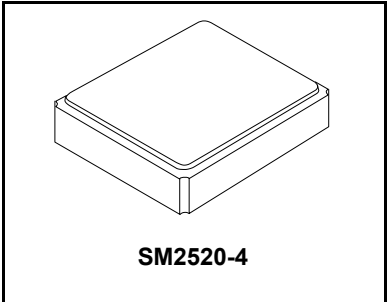


**XO8001**

**100.00000 MHz**  
**XO**



**Features:**

- Surface Mount Seam Weld Package
- Excellent Reliability Performance
- Excellent Frequency Perturbation and Stability over temperature
- Moisture Sensitivity Level (MSL) : Level-1

**Application:**

- Supply Voltage CMOS Output
- Option-able stand-by functions for output.

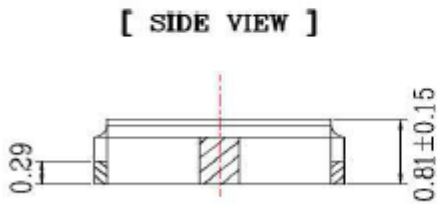
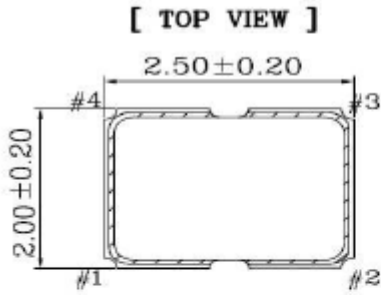
**Electrical Characteristics:**

<b>XO8001</b>	<b>Specifications</b>
Nominal Frequency, Fo	100.00000MHz
Storage Temperature Range	-55°C to +125°C
Operating Temperature Range	-40°C to +85°C
Power Supply Voltage, Vcc	3.3 V +/- 10%
Load	15pF
“0” Level “1” Level	Vol: 10%Vcc max Voh:90%Vcc min
Frequency Stability <sup>1</sup>	+/-30 ppm max
Duty Cycle	45% ~ 55%
Power Supply Current, Icc	15 mA max
Rise Time ( 10% -> 90% of final RF level in Vp-p ) Fall Time ( 90% -> 10% of final RF level in Vp-p )	3 nsec max.
Unit Weight	14 +/-0.5mg
Aging	3 ppm/first year
Enable/Disable Function	PIN 1: Vih:70%Vcc min or Open, PIN 3: Output Enable PIN 1: Vil:30%Vcc max, PIN 3:Output Disable

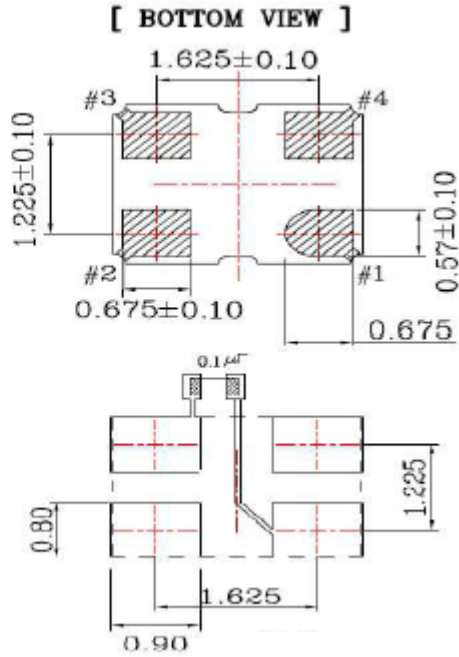
#Note 1: Frequency accuracy includes 25C tolerance, operating temperature range -40 to 85 deg C, first year of aging and voltage or load change

# Mechanical Dimensions: (Unit: mm)

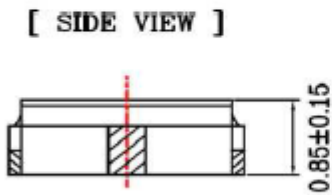
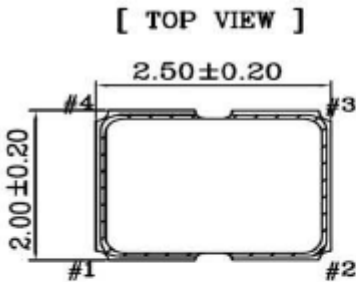
## Base 1



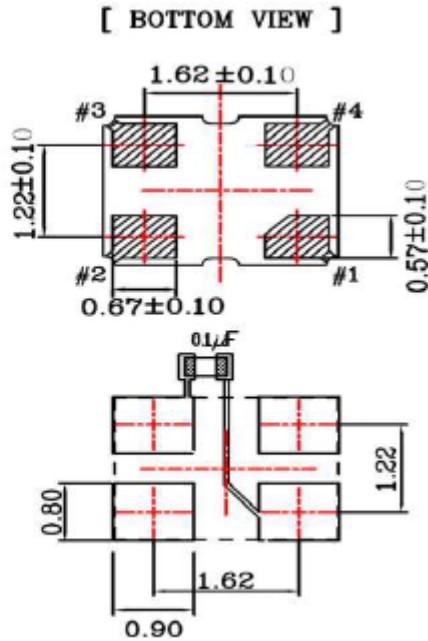
★ To ensure optimal oscillator performance. Place a by-pass capacitor of 0.1μF as close to the part as possible between VDD and GND pads.



## Base 2



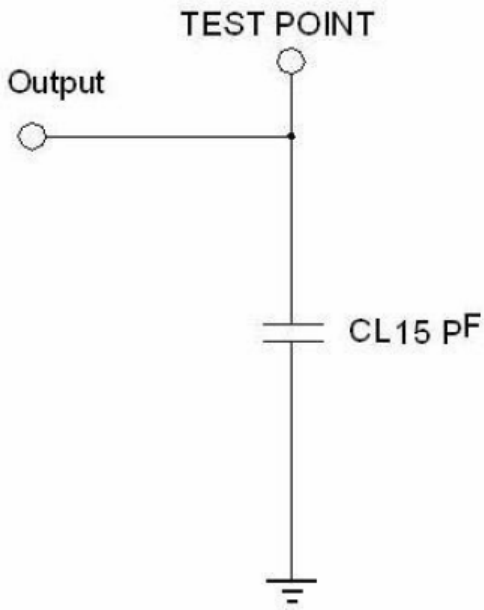
★ To ensure optimal oscillator performance. Place a by-pass capacitor of 0.1μF as close to the part as possible between VDD and GND pads.



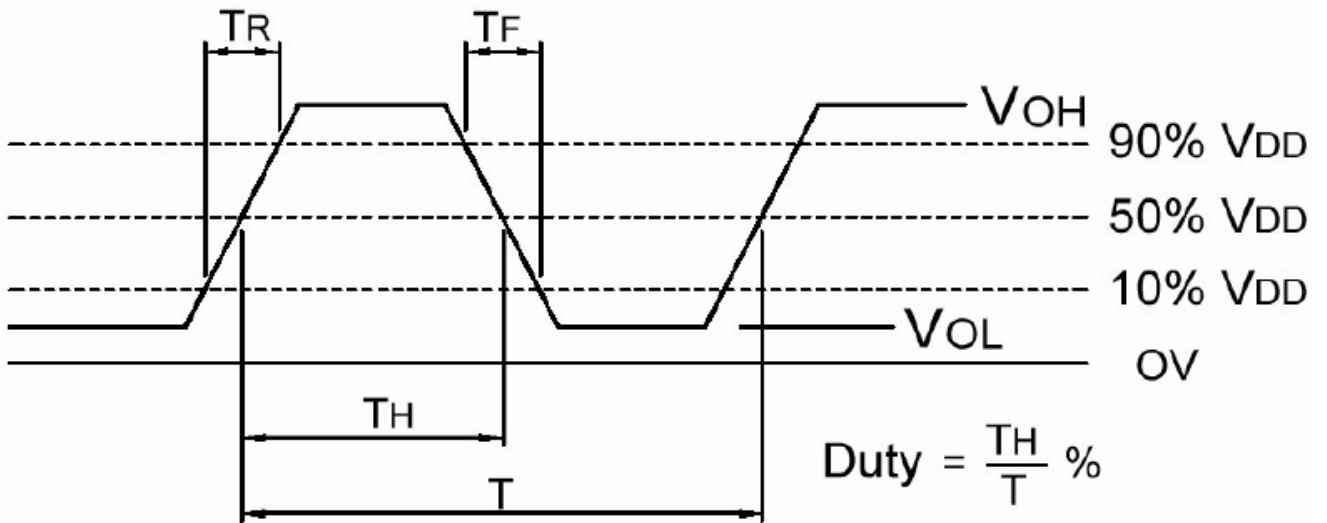
## PIN FUNCTIONS

Pin	Function
#1	Tri-State
#2	GND
#3	Output
#4	V <sub>DD</sub>

## Test Circuit:



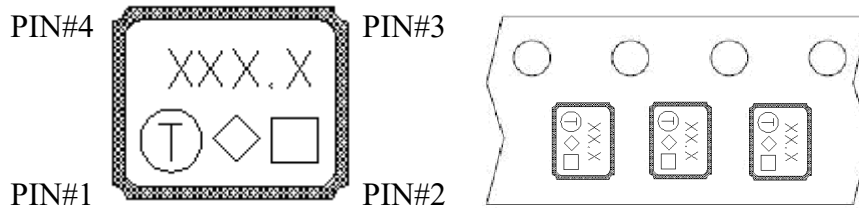
## Output Waveform :



# Marking:

Line 1: Frequency (100.0)

Line 2: Date Code (◇) + Product Code (□ Internal tracking code, could be a~z and A~Z, 1 or 2 letters, underline or no underline)



The inner vision of PIN#1, PIN#4 side is XTAL blank mounting pad.

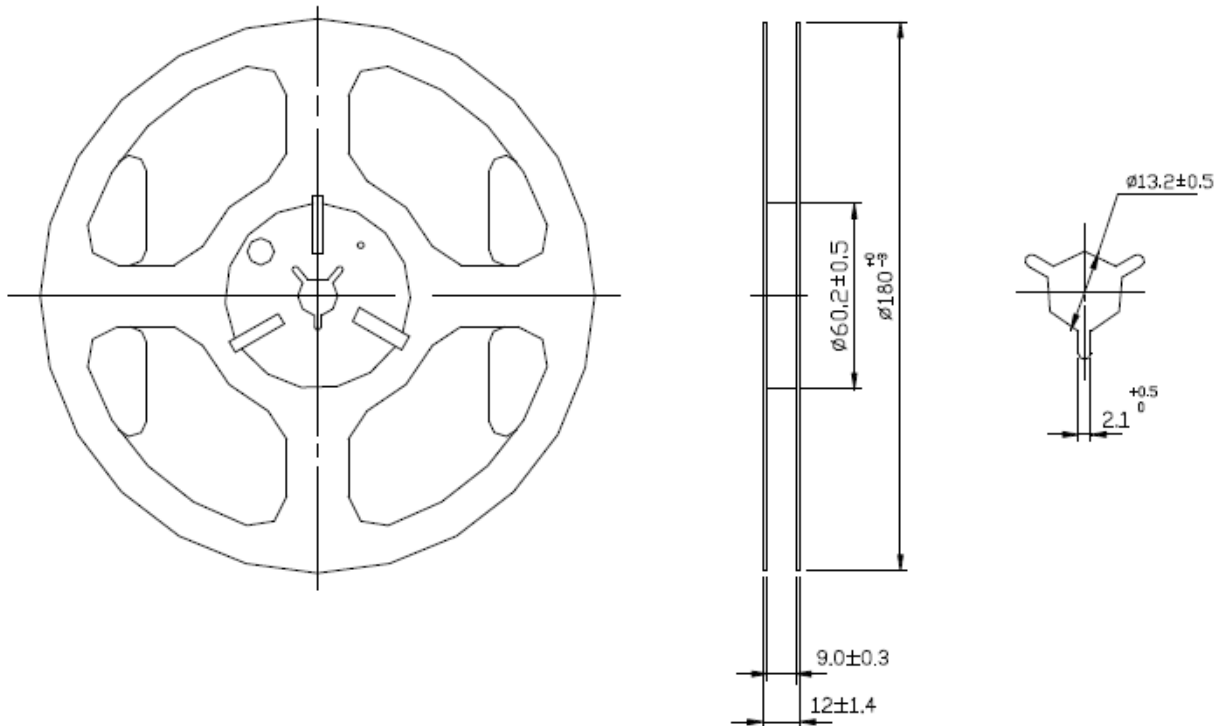
## ◇: Date Code Table

WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
A	B	C	D	E	F	G	H	I	J	K	L	M
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
N	O	P	Q	R	S	T	U	V	W	X	Y	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
a	b	c	d	e	f	g	h	i	j	k	l	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	o	p	q	r	s	t	u	v	w	x	y	z

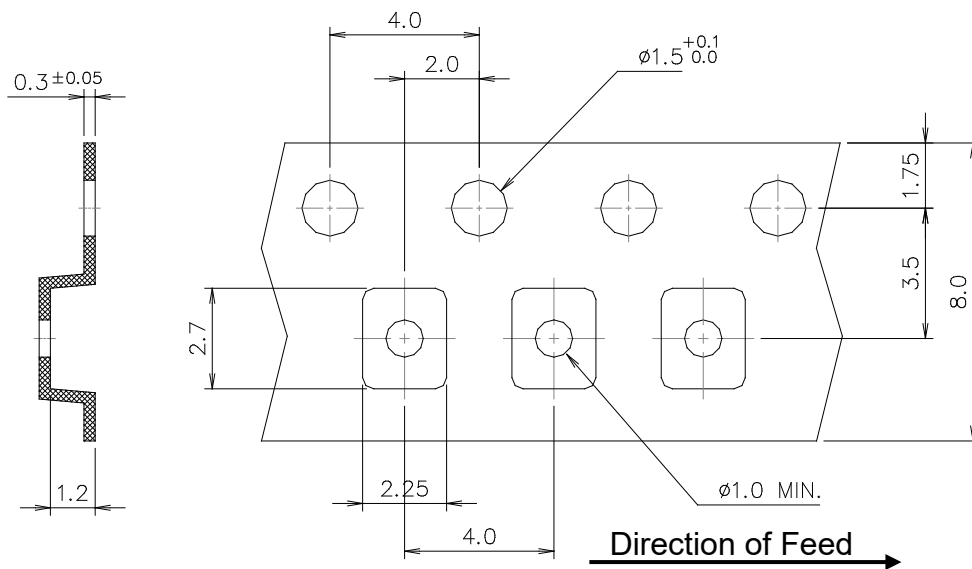
## Product Code Table: (Under line With Even Year and Odd Year for Nothing)

Year						Product Code
2013	2015	2017	2019	2021	2023	□
2014	2016	2018	2020	2022	2024	□

## Reel Dimensions (mm):



## Tape Dimensions (mm):



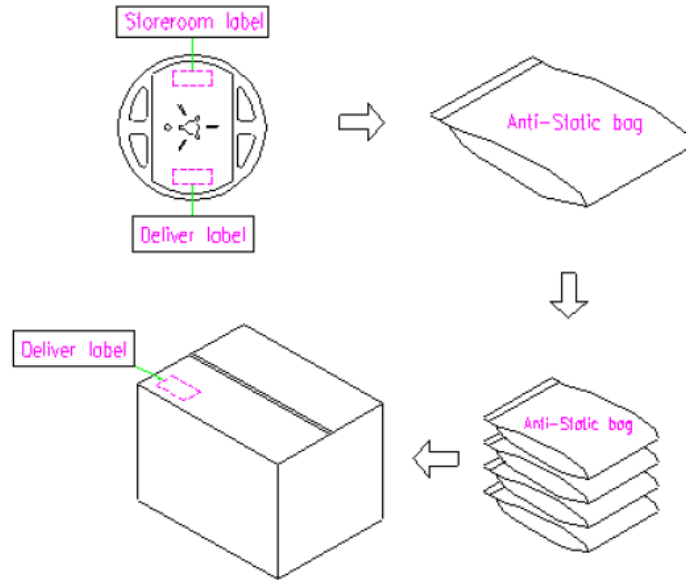
### [NOTE]:

1. Unless otherwise specified tolerance on dimension  $\pm 0.1$  mm.
2. Material: conductive polystyrene with color black.
3. 10 pitch cumulative tolerance  $\pm 0.2$  mm.

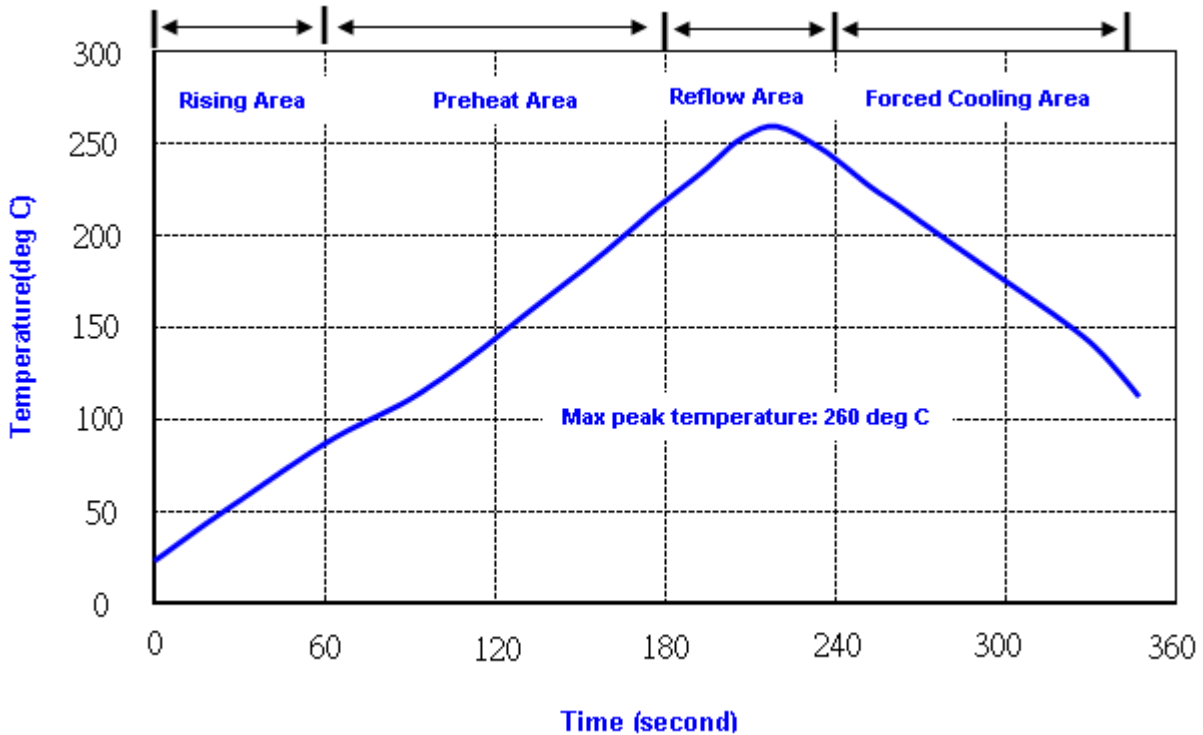
# Packing Quantity/Packing:

3Kpcs per reel

Packing Quantity/Packing:



## Reflow Profile:



- Note: 1. Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec
- 2. Temperature: 217+/-5 deg C; Time: 90~100 sec

## Reliability Specifications

Test name	Test process / method	Reference standard
<b>Mechanical characteristics</b>		
resistance to Soldering heat (IR reflow)	Temp./ Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)
Vibration	Total peak amplitude : 1.5mm Vibration frequency : 10 to 2000 Hz Sweep period : 20 minute Vibration directions : 3 mutually perpendicular Duration : 2 hr / direc.	MIL-STD 202G method 204
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213
Solderability	Solder Temperature:265±5°C Duration time: 5±0.5 seconds.	J-STD-002
<b>Environmental characteristics</b>		
Thermal Shock	Heat cycle conditions -40 °C (30min) ↔ 85 °C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8
Humidity test	Temperature : 85 ± 2 °C Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103
Dry heat ( Aging test )	Temperature : 125 ± 2 °C Duration : 168 hours	MIL-STD 202G method 108A
Cold resistance (Low Temp Storage)	Temperature : -40 ± 2 °C Duration : 96 hours	IEC 60068-2-1



**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.